

SPECIFICATION SHEET

	00745 04505040750404				
SPECIFICATION SHEET NO.	Q0715-SAF868M275S134				
DATE	July 15, 2023				
REVISION	AO				
DESCRIPITION	SMD SAW Filter L5.0*W5.0*H1. 50mm 5050 Type 8 Pads SAF Series				
	868.27500MHz, Insertion Loss: 5.4 dB Typical				
	Bandwidth: 0.70MHz				
	Operating Temp. Range -40°C ~+85°C,				
	Reflow Profile Condition 260 °C Max. Tape/Reel, 1000pcs/Reel				
	RoHS/RoHS III compliant				
CUSTOMER					
CUSTOMER PART NUMBER					
CROSS REF. PART NUMBER					
ORIGINAL PART NUMBER	TGS SAF 868.275MA TLF				
PART CODE	SAF868M275S134				

VENDOR APPROVE

Issued/Checked/Approved







DATE: July 15, 2023

CUSTOMER APPROVE	
DATF:	

7/16/2023



SMD SAW FILTER 5050 TYPE SAF SERIES

MAIN FEATURE

- SMD SAW Filter L5.0*W5.0*H1. 50mm 5050 Type 8 Pads
- Low-loss SAW Components
- Low Amplitude Ripple
- Sharp Rejection As Both Out-bands
- Usable Passband 0.70MHz
- Package code QCC8C
- Electronic Sensitive Device (ESD)
- Cross More Competitors Part
- RoHS/RoHS III Compliant

APPLICATION

- Bluetooth, wireless communication set
- Communication Electronics

PART CODE GUIDE



SAF	868M275	S	134
1	2	3	4

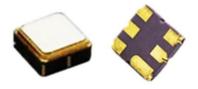
- 1) SAF: SMD SAW Filter L5.0*W5.0*H1.50mm 5050 Type 8 Pads SAF Series
- 2) 868M275: Frequency range code for 868.2750MHz
- 3) S: SMD type, Package Tape/Reel,
- 4) 134: Internal code (A~Z or 1~9 or Blank) for custom specification

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DIMENSION (Unit: mm, Tol.: +-0.15mm)

Image for reference



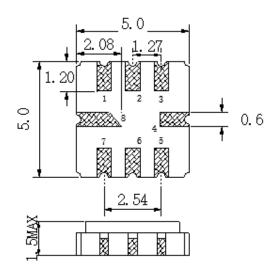
Marking

Line 1: Internal code

Line 2: ● Pin 1 + Special code

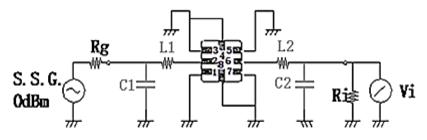
SAF series

L5.0*W5.0*H1.50mm 5050 Type

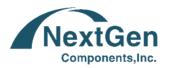


Pin	Configuration	
2	Input	
6	Output	
1,3,5,7	To be	
	Grounded	
4,8	Case Ground	

Test Circuit (Bottom View)



L1=L2=8.2nh C1=C2=9PF Rg=Ri=50Ω



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ELECTRICAL PARAMETERS

Parameter		Part No. Symbol	Units		Value	
		Symbol		Min.	Typical	Max.
Original Manufact	urer	TGS			TGS Crysta	ls
Holder Type		SAF		SMD SAW Filter, L5.0*W5.0*H1.50mm 5050 Type 8 Pads		50mm
Center Frequency	(fc)	868.275M	MHz		868.27500)
DC Voltage (VDC)		А	V		3.0	
Operation Temper	rature Range (T)		°C	-40		+85
Storage Temperature Range (Tstg)			°C	-40		+85
RF Power Dissipation (P)			dBm		10	
Insertion Loss (Min.) (IL)			dB		5.4	6.0
Amplitude Ripple	(p-p) (△a)		dB		0.5	1.0
1 dB Bandwidth B	dB Bandwidth BW1dB		MHz	0.7	0.9	
3 dB Bandwidth BW3dB			MHz	1.0	1.3	
Absolute Delay 86	8.275MHz		ns		450.0	1500.00
Group Delay Rippl	e 867.925-868.625MHz (GDR)		ns	200.0 25		250.00
Aging (Absolute V	alue during the First Year)		ppm/y	≤±10		
Input VSWR 915.0	0 -917.00 MHz			/ /		/
Output VSWR 915	.00 -917.00 MHz				/	/
Absolute	848.00 MHz	348.00 MHz dB 30	30.0	48.0		
Attenuation (a)	enuation (α) 866.00 MHz	20.0	35.0			
	870.00 MHz	.00 MHz 15.0	15.0	20.0		
	888.00 MHz			30.0	42.0	
Dackage		Т			Tana/Das	1
Package				Tape/Reel		
RoHS Status Add Value		LF		RoHS III compliant		
Internal Control Co				Blank: N/A Blank: N/A		

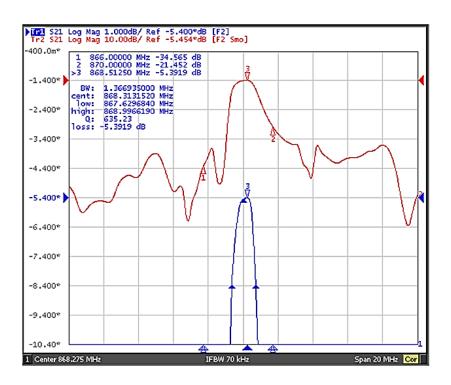
Electronic Characteristics: 1) Test Temperature: $25^{\circ}C\pm 2^{\circ}C$ 2) Terminating source impedance: 50Ω 3) Terminating load

impedance: 50Ω

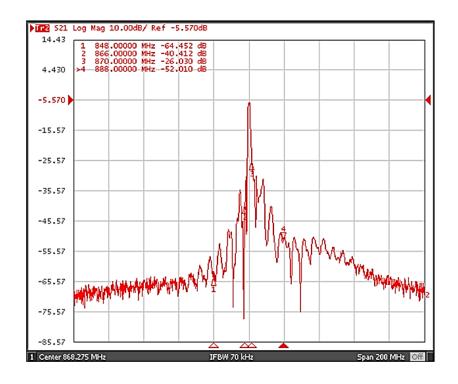
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FREQUENCY CHARACTERISTICS



Frequency Response



Frequency Response (wideband)

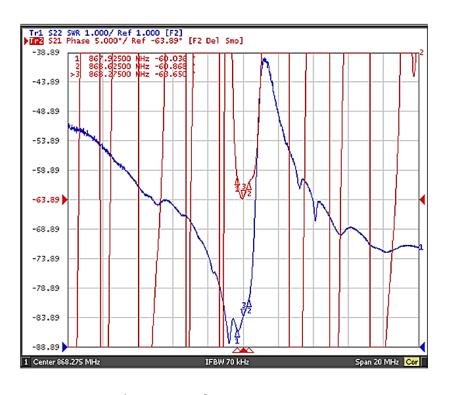
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FREQUENCY CHARACTERISTICS



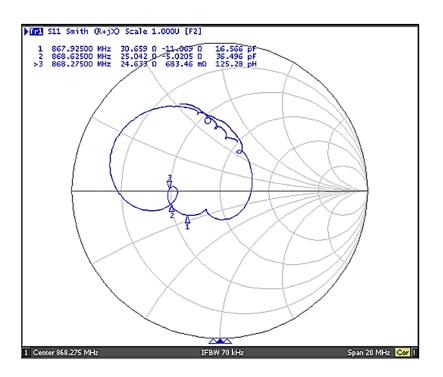
Delay Ripple & S11 VSWR



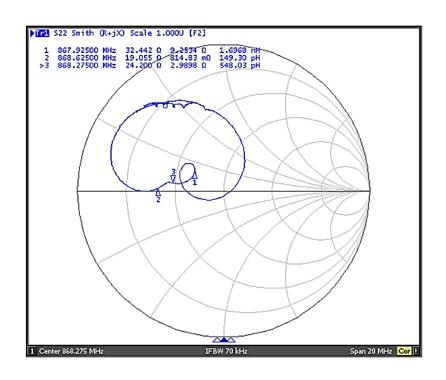
Phase Linearity & S22 VSWR



FREQUENCY CHARACTERISTICS



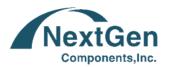
S11 Smith Chart



S22 Smith Chart

sales@NextGenComponent.com

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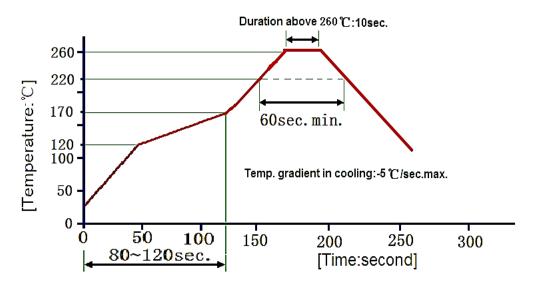
SMD SAW FILTER 5050 TYPE SAF SERIES

RELIABILITY

Test Items	Test Method And Conditions	Requirement		
Temperature Storage	(1) Temperature: $85^{\circ}C\pm2^{\circ}C$, Duration: $250h$, Recovery time: $2h\pm0.5h$ (2) Temperature: $-55^{\circ}C\pm3^{\circ}C$, Duration: $250h$, Recovery time: $2h\pm0.5h$	It shall remain electrical performance after tests		
Humidity Test	Conditions: 60°C±2°C , 90~95% RH Duration: 250h			
Thermal Shock	Heat cycle conditions: TA=-55°C±3°C, TB=85°C±2°C, t1=t2=30min, Switch time: ≤3min, Cycle time: 100 times, Recovery time: 2h±0.5h.			
Vibration Fatigue	Frequency of vibration: 10~55Hz Amplitude:1.5mm Directions: X,Y and Z Duration: 2h			
Drop Test	Cycle time: 10 times Height: 1.0m			
Solderability	Temperature: 245°C±5°C Duration: 3.0s5.0s Depth: DIP2/3 , SMD1/5			
Resistance to Soldering Heat	(1)Thickness of PCB:1mm , Solder condition: $260^{\circ}C\pm5^{\circ}C$, Duration: $10\pm1s$ (2)Temperature of Soldering Iron: $350^{\circ}C\pm10^{\circ}C$, Duration: $3^{\sim}4s$, Recovery time : $2\pm0.5h$			



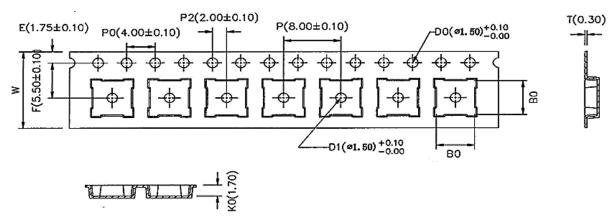
SUGGESTED REFLOW PROFILE (For Reference Only)



Reflow cycles:3 cycles max.

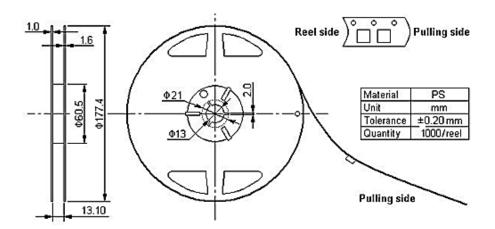
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TAPE DIMENSION (Unit: mm, 3000pcs/Reel)



^{*} B0: 5.35 for QCC8C; 4.15 for DCC6/QCC8B; 3.35 for DCC6C/QCC8D

REEL DIMENSION (Unit: mm)



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CAUTION

- 1. As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to ESD protect in the test.
- Static voltage between signal load and ground may cause deterioration and destruction of the component.
 Please avoid static voltage.
- Ultrasonic cleaning may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.
- 4. Only leads of component may be soldered. Please avoid soldering another part of component.
- 5. There is a close relationship between the device's performance and matching network. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.
- 6. The temperature of manual welding should not exceed 300 °C.
- 7. The specifications of this device are based on the test circuit shown above and subject to change or obsolescence without notice.
- 8. All equipment designs utilizing this product must be approved by the appropriate government agency prior to manufacture or sale.
- 9. Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) perse, not for applications, processes and circuits implemented within components or assemblies.
- 10. For questions on technology, prices and delivery, please contact our sales offices or e-mail: sales@NextGenComponent.com.

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